<0.4 Ω CMOS 1.8 V to 5.5 V SPST Switches

Data Sheet

ADG801/ADG802

FEATURES

0.4 Ω maximum on resistance at 125°C
0.08 Ω maximum on resistance flatness at 125°C
1.8 V to 5.5 V single supply
Automotive temperature range from −40°C to +125°C
400 mA current-carrying capability
Tiny 6-lead SOT-23 and 8-lead MSOP packages
35 ns switching times
Low power consumption
TTL-/CMOS-compatible inputs
Pin compatible with ADG701/ADG702

APPLICATIONS

Power routing
Cellular phones
Modems
PCMCIA cards
Hard drives
Data acquisition systems
Communications systems
Relay replacement
Battery-powered systems

FUNCTIONAL BLOCK DIAGRAM

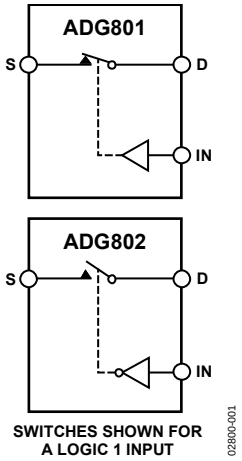

Figure 1.

GENERAL DESCRIPTION

The ADG801 and ADG802 are monolithic CMOS, single-pole, single throw (SPST) switches with on resistance of less than 0.4 Ω. These switches are designed using an advanced submicron process that provides extremely low on resistance, high switching speed, and low leakage currents.

The low on resistance of <0.4 Ω makes these parts ideal for applications where low on resistance switching is critical.

The ADG801 switch is normally open (NO), while the ADG802 is normally closed (NC). Each switch conducts equally well in both directions when on.

PRODUCT HIGHLIGHTS

1. Low on resistance (0.25 Ω typical).
2. 1.8 V to 5.5 V single-supply operation.
3. Tiny 6-lead SOT-23 and 8-lead MSOP packages.
4. 400 mA current-carrying capability.
5. Automotive temperature range from −40°C to +125°C.
6. Pin compatible with ADG701 (ADG801) and ADG702 (ADG802).

Rev. B

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REVISION HISTORY

1/12—Rev. A to Rev. B

Deleted 6-Ball WLCSP Package ... Universal
Added Table Title to Table 3; Renumbered Sequentially ... 5
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Updated Outline Dimensions ... 12
Deleted Figure 23 ... 13
Changes to Ordering Guide ... 13

3/07—Rev. 0 to Rev. A

Updated Format ... Universal
Added 6-Ball WLCSP Package (Text and Figures) ... Universal
Replaced Typical Performance Characteristics Section ... 8
Updated Outline Dimensions ... 12
Changes to Ordering Guide ... 14

5/02—Revision 0: Initial Version

SPECIFICATIONS

V_{DD} = 5 V ± 10%, GND = 0 V, unless otherwise noted. The automotive temperature range is −40°C to +125°C.

Table 1.

Parameter	25°C	−40°C to +85°C	−40°C to +125°C[1]	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V_{DD}	V	
On Resistance (R_{ON})	0.25			Ω typ	V_S = 0 V to V_{DD}, I_S = 100 mA; see Figure 13
	0.3	0.35	0.4	Ω max	V_S = 0 V to V_{DD}, I_S = 100 mA; see Figure 13
On Resistance Flatness ($R_{FLAT(ON)}$)	0.05			Ω typ	V_S = 0 V to V_{DD}, I_S = 100 mA
		0.07	0.08	Ω max	
LEAKAGE CURRENTS					V_{DD} = 5.5 V
Source Off Leakage, I_S (Off)	±0.01			nA typ	V_S = 4.5 V/1 V, V_D = 1 V/4.5 V; see Figure 14
	±0.25	±3	±30	nA max	V_S = 4.5 V/1 V, V_D = 1 V/4.5 V; see Figure 14
Drain Off Leakage, I_D (Off)	±0.01			nA typ	V_S = 4.5 V/1 V, V_D = 1 V/4.5 V; see Figure 14
	±0.25	±3	±30	nA max	V_S = 4.5 V/1 V, V_D = 1 V/4.5 V; see Figure 14
Channel On Leakage, I_D, I_S (On)	±0.01			nA typ	V_S = V_D = 1 V, or 4.5 V; see Figure 15
	±0.25	±3	±30	nA max	V_S = V_D = 1 V, or 4.5 V; see Figure 15
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current					
I_{INL} or I_{INH}	0.005			μA typ	V_{IN} = V_{INL} or V_{INH}
			±0.1	μA max	
C_{IN}, Digital Input Capacitance	5			pF typ	
DYNAMIC CHARACTERISTICS[2]					
t_{ON}	35			ns typ	R_L = 50 Ω, C_L = 35 pF
	45	50	55	ns max	V_S = 3 V; see Figure 16
t_{OFF}	9			ns typ	R_L = 50 Ω, C_L = 35 pF
	15	18	21	ns max	V_S = 3 V; see Figure 16
Charge Injection	50			pC typ	V_S = 2.5 V, R_S = 0 Ω; C_L = 1 nF; see Figure 17
Off Isolation	−61			dB typ	R_L = 50 Ω, C_L = 5 pF; f = 100 kHz; see Figure 18
Bandwidth −3 dB	12			MHz typ	R_L = 50 Ω, C_L = 5 pF; see Figure 19
C_S (Off)	180			pF typ	f = 1 MHz
C_D (Off)	180			pF typ	f = 1 MHz
C_D, C_S (On)	420			pF typ	f = 1 MHz
POWER REQUIREMENTS					V_{DD} = 5.5 V
I_{DD}	0.001			μA typ	Digital inputs = 0 V or 5.5 V
		1.0	2.0	μA max	

[1] On resistance parameters tested with I_S = 10 mA.
[2] Guaranteed by design, not subject to production test.

V_{DD} = 2.7 V to 3.6 V, GND = 0 V, unless otherwise noted. The automotive temperature range is −40°C to +125°C.

Table 2.

Parameter	25°C	−40°C to +85°C	−40°C to +125°C[1]	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V_{DD}	V	
On Resistance (R_{ON})	0.4			Ω typ	V_S = 0 V to V_{DD}, I_S = 100 mA; see Figure 13
	0.6	0.65	0.7	Ω max	V_S = 0 V to V_{DD}, I_S = 100 mA; see Figure 13
On Resistance Flatness ($R_{FLAT(ON)}$)	0.1	0.1	0.1	Ω typ	V_S = 0 V to V_{DD}, I_S = 100 mA
LEAKAGE CURRENTS					V_{DD} = 3.6 V
Source Off Leakage, I_S (Off)	±0.01			nA typ	V_S = 3.3 V/1 V, V_D = 1 V/3.3 V; see Figure 14
	±0.25	±3	±30	nA max	V_S = 3.3 V/1 V, V_D = 1 V/3.3 V; see Figure 14
Drain Off Leakage, I_D (Off)	±0.01			nA typ	V_S = 3.3 V/1 V, V_D = 1 V/3.3 V; see Figure 14
	±0.25	±3	±30	nA max	V_S = 3.3 V/1 V, V_D = 1 V/3.3 V; see Figure 14
Channel On Leakage, I_D, I_S (On)	±0.01			nA typ	V_S = V_D = 1 V, or 3.3 V; see Figure 15
	±0.25	±3	±30	nA max	V_S = V_D = 1 V, or 3.3 V; see Figure 15
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current					
I_{INL} or I_{INH}	0.005			μA typ	V_{IN} = V_{INL} or V_{INH}
			±0.1	μA max	
C_{IN}, Digital Input Capacitance	5			pF typ	
DYNAMIC CHARACTERISTICS[2]					
t_{ON}	40			ns typ	R_L = 50 Ω, C_L = 35 pF
	55	60	65	ns max	V_S = 1.5 V; see Figure 16
t_{OFF}	9			ns typ	R_L = 50 Ω, C_L = 35 pF
	15	18	21	ns max	V_S = 1.5 V; see Figure 16
Charge Injection	10			pC typ	V_S = 1.5 V, R_S = 0 Ω, C_L = 1 nF; see Figure 17
Off Isolation	−61			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 100 kHz; see Figure 18
Bandwidth −3 dB	12			MHz typ	R_L = 50 Ω, C_L = 5 pF; see Figure 19
C_S (Off)	180			pF typ	f = 1 MHz
C_D (Off)	180			pF typ	f = 1 MHz
C_D, C_S (On)	420			pF typ	f = 1 MHz
POWER REQUIREMENTS					V_{DD} = 3.6 V
I_{DD}	0.001			μA typ	Digital inputs = 0 V or 3.6 V
		1.0	2.0	μA max	

[1] On resistance parameters tested with I_S = 10 mA.
[2] Guaranteed by design, not subject to production test.

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 3.

Parameter	Rating
V_{DD} to GND	−0.3 V to +7 V
Analog Inputs[1]	−0.3 V to VDD + 0.3 V or 30 mA, whichever occurs first
Digital Inputs[1]	−0.3 V to VDD + 0.3 V or 30 mA, whichever occurs first
Continuous Current, Pin S or Pin D	400 mA
Peak Current, Pin S or Pin D	800 mA, pulsed at 1 ms, 10% duty cycle max
Operating Temperature Range Automotive	−40°C to +125°C
Storage Temperature Range	−65°C to +150°C
Junction Temperature (T_{JMAX})	150°C
Package Power Dissipation	$(T_{JMAX} - T_A)/\theta_{JA}$
MSOP	
θ_{JA} Thermal Impedance	206°C/W
θ_{JC} Thermal Impedance	44°C/W
SOT-23 (4-Layer Board)	
θ_{JA} Thermal Impedance	119°C/W
θ_{JC} Thermal Impedance	91.99°C/W
Lead Temperature, Soldering (10 sec)	300°C
IR Reflow, Peak Temperature (<20 sec)	235°C
Reflow Soldering (Pb-Free)	
Peak Temperature	260(+0/−5)°C
Time at Peak Temperature	10 sec to 40 sec

[1] Overvoltages at Pin IN, Pin S, or Pin D are clamped by internal diodes. Current should be limited to the maximum ratings provided.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 4. Truth Table

ADG801 (Pin IN)	ADG802 (Pin IN)	Switch Condition
0	1	Off
1	0	On

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

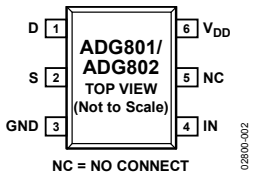


Figure 2. 6-Lead SOT-23 (RJ-6)

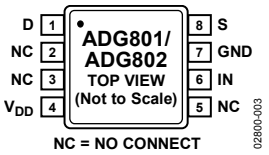


Figure 3. 8-Lead MSOP (RM-8)

Table 5. Pin Function Descriptions

Pin Number			
SOT-23	**MSOP**	**Mnemonic**	**Description**
1	1	D	Drain Terminal. Can be an input or an output.
2	8	S	Source Terminal. Can be an input or an output.
3	7	GND	Ground (0 V) Reference.
4	6	IN	Logic Control Input.
5	2, 3, 5	NC	No Connect. Do not connect to this pin.
6	4	V_{DD}	Most Positive Power Supply Potential.

TYPICAL PERFORMANCE CHARACTERISTICS

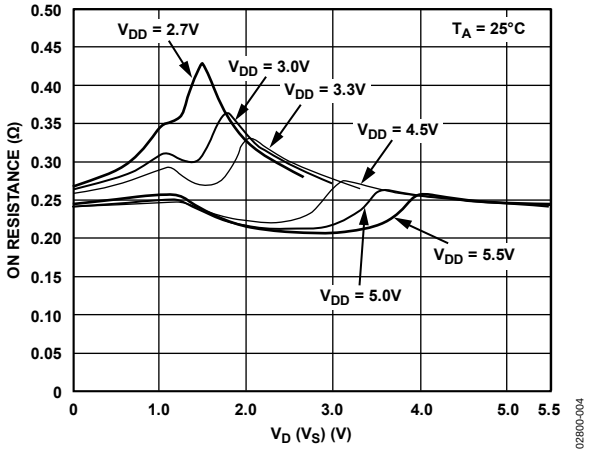


Figure 4. On Resistance vs. V_D (V_S)

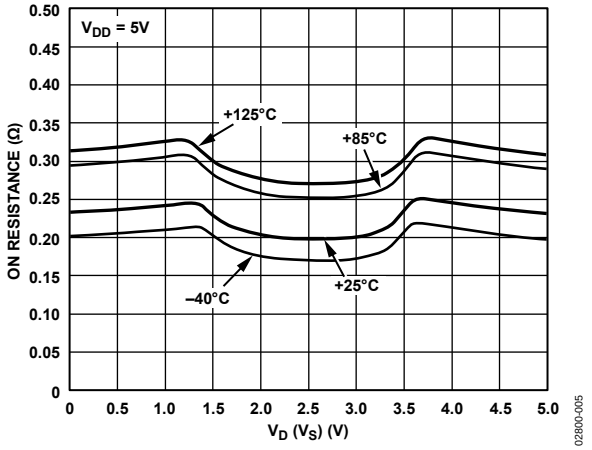


Figure 5. On Resistance vs. V_D (V_S) for Different Temperatures

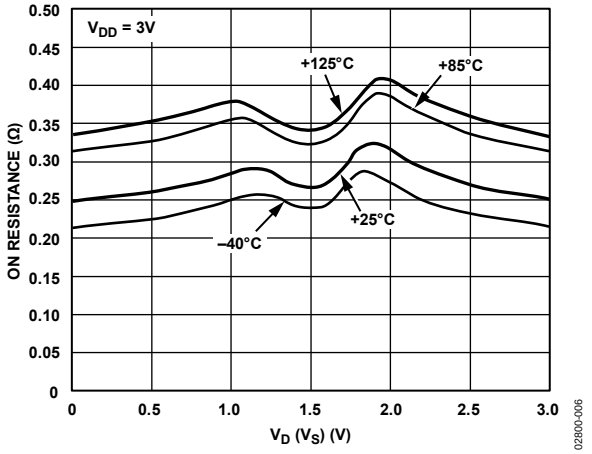


Figure 6. On Resistance vs. V_D (V_S) for Different Temperatures

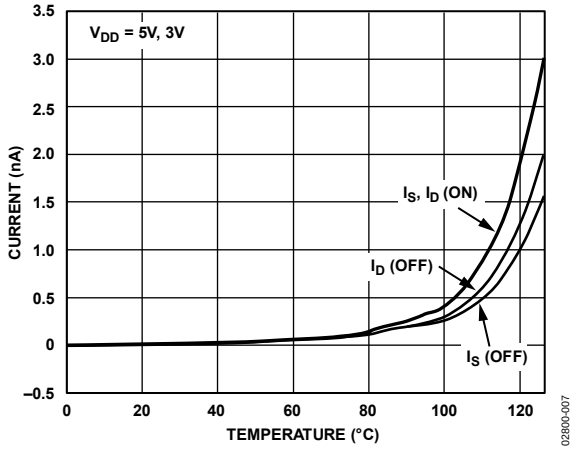


Figure 7. Leakage Current vs. Temperature

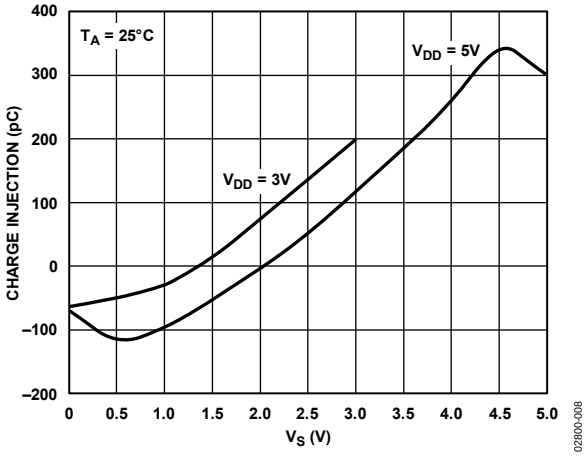


Figure 8. Charge Injection vs. Source Voltage

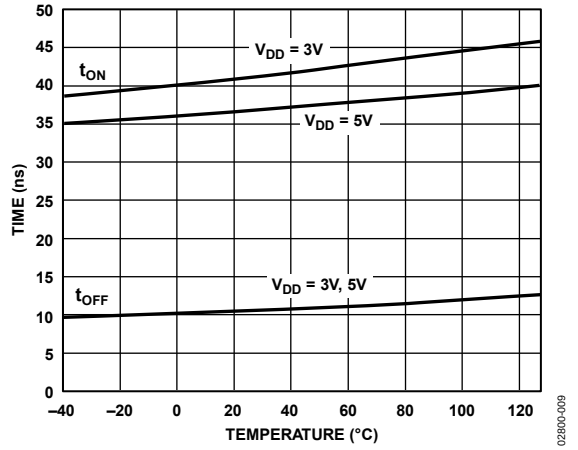


Figure 9. t_{ON}/t_{OFF} Times vs. Temperature

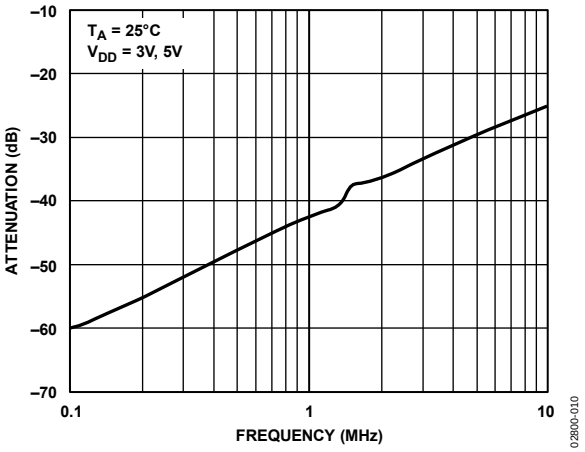


Figure 10. Off Isolation vs. Frequency

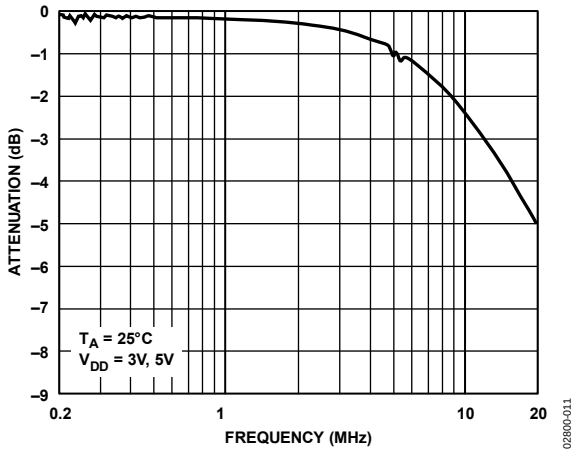


Figure 11. On Response vs. Frequency

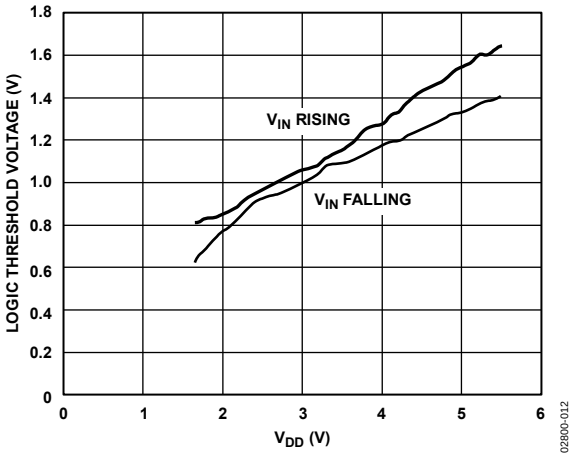


Figure 12. Logic Threshold Voltage vs. Supply Voltage

TERMINOLOGY

V_{DD}
The most positive power supply potential.

I_{DD}
Positive supply current.

GND
Ground (0 V) reference.

S
The source terminal can be an input or an output.

D
The drain terminal can be an input or an output.

IN
Logic control input.

V_D (V_S)
Analog voltage on Terminal D and Terminal S.

R_{ON}
Ohmic resistance between Terminal D and Terminal S.

$R_{FLAT(ON)}$
The difference between the maximum and minimum value of on resistance as measured over the specified analog signal range.

I_S (Off)
Source leakage current with the switch off.

I_D (Off)
Drain leakage current with the switch off.

I_D, I_S (On)
Channel leakage current with the switch on.

V_{INL}
Maximum input voltage for Logic 0.

V_{INH}
Minimum input voltage for Logic 1.

I_{INL} (I_{INH})
Input current of the digital input.

C_S (Off)
The off switch source capacitance is measured with reference to ground.

C_D (Off)
The off switch drain capacitance is measured with reference to ground.

C_D, C_S (On)
The on switch capacitance is measured with reference to ground.

C_{IN}
Digital input capacitance.

t_{ON}
The delay between applying the digital control input and when the output switches on. See Figure 16.

t_{OFF}
The delay between applying the digital control input and when the output switches off.

Charge Injection
A measure of the glitch impulse transferred from the digital input to the analog output during switching.

Off Isolation
A measure of unwanted signal coupling through an off switch.

Bandwidth
The frequency at which the output is attenuated by 3 dB.

On Response
The frequency response of the on switch.

Insertion Loss
The loss due to the on resistance of the switch.

TEST CIRCUITS

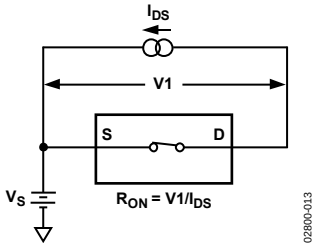


Figure 13. On Resistance

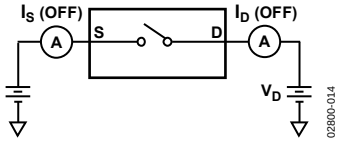


Figure 14. Off Leakage

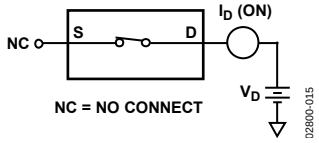


Figure 15. On Leakage

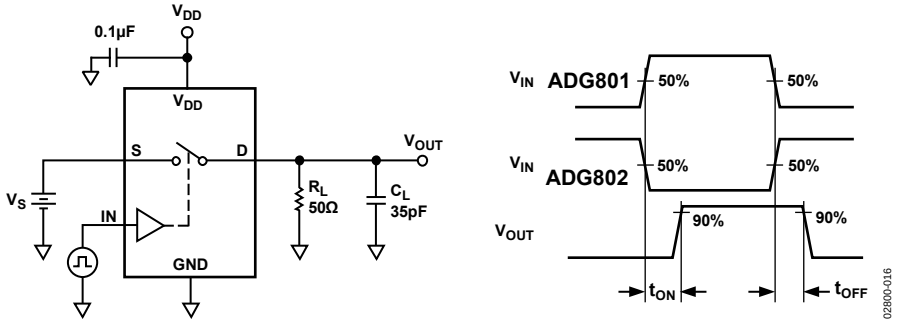


Figure 16. Switching Times

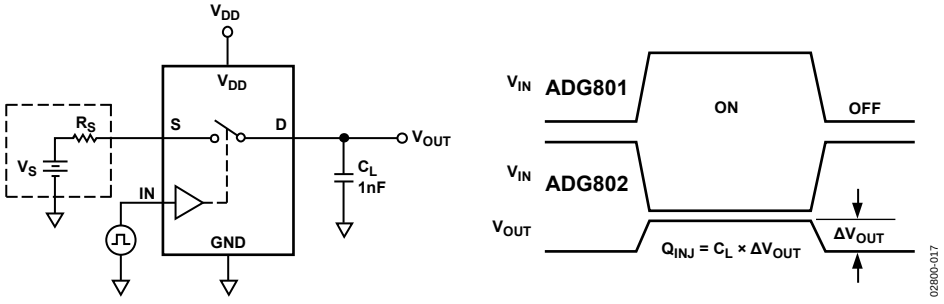


Figure 17. Charge Injection

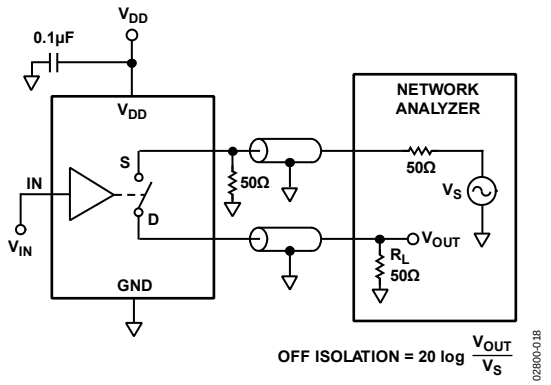


Figure 18. Off Isolation

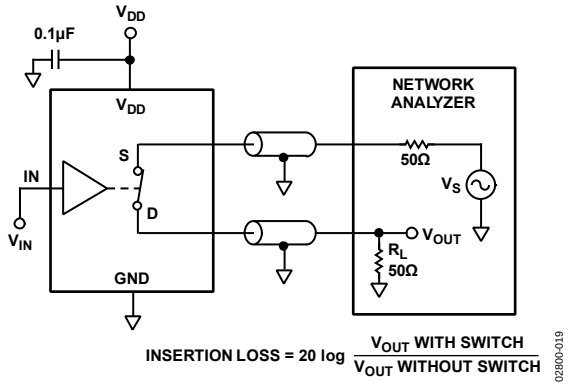
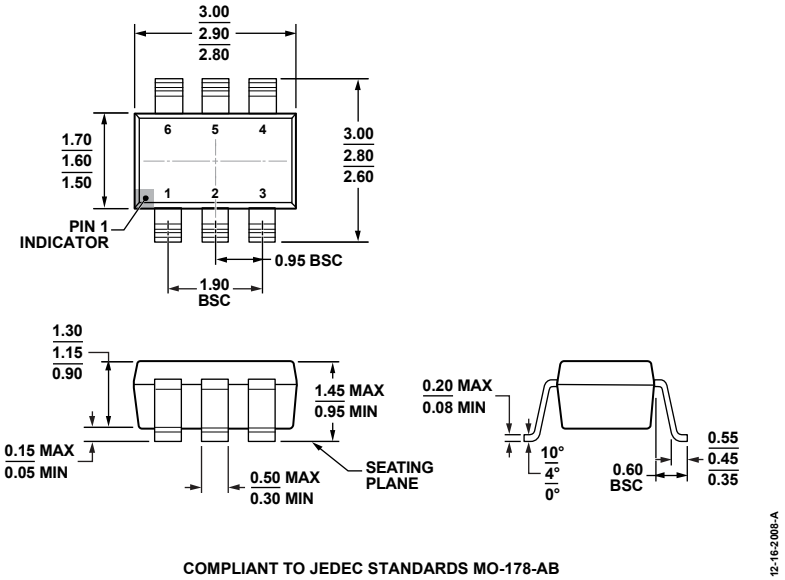


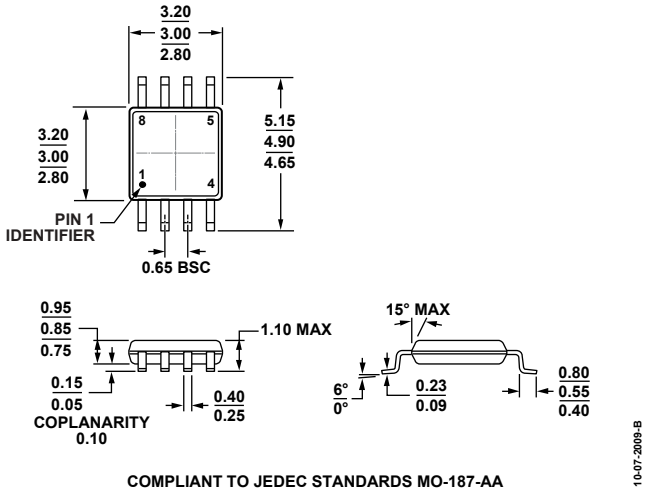
Figure 19. Bandwidth

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-178-AB

Figure 20. 6-Lead Small Outline Transistor Package [SOT-23]
(RJ-6)
Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 21. 8-Lead Mini Small Outline Package [MSOP]
(RM-8)
Dimensions shown in millimeters

ORDERING GUIDE

Model[1]	Temperature Range	Package Description	Package Option	Branding[2]
ADG801BRM	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	SLB
ADG801BRM-REEL	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	SLB
ADG801BRM-REEL7	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	SLB
ADG801BRMZ	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S06
ADG801BRMZ-REEL	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S06
ADG801BRMZ-REEL7	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S06
ADG801BRT-500RL7	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	SLB
ADG801BRT-REEL7	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	SLB
ADG801BRTZ-500RL7	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	S06
ADG801BRTZ-REEL	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	S06
ADG801BRTZ-REEL7	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	S06
ADG802BRM	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	SMB
ADG802BRM-REEL	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	SMB
ADG802BRM-REEL7	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	SMB
ADG802BRMZ	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S0F
ADG802BRMZ-REEL	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S0F
ADG802BRMZ-REEL7	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S0F
ADG802BRT-500RL7	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	SMB
ADG802BRTZ-500RL7	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	S0F
ADG802BRTZ-REEL	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	S0F
ADG802BRTZ-REEL7	−40°C to +125°C	6-Lead Small Outline Transistor Package [SOT-23]	RJ-6	S0F

[1] Z = RoHS Compliant Part.
[2] Branding on SOT-23 and MSOP packages is limited to three characters due to space constraints.

NOTES

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D02800-0-1/12(B)